

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
JIANGFAN YAN	01/23/2016
QUAN ZHONG	01/23/2016
WEI PENG	01/23/2016
TIANYUE MA	01/23/2016
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PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	29552725
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DATE SIGNED:	01/29/2016
Total Attachments: 3	
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ASSIGNMENT

WHEREAS, we, Jiangfan YAN of China, Quan ZHONG of China, Wei PENG of China, and Tianyue MA of China, ("Assignor"), are the inventors of an invention entitled "Endoscope" that is the subject matter of. (Check all that apply)

- ☒ a U.S. application for Letters Patent which claims the priority of Chinese Patent Application No. 201530395355.0 filed on October 14, 2015.
- ☐ an application made under the Patent Cooperation Treaty which is identifiable at WIPO by Application No. _____ filed on _____
- ☒ an application for Letters Patent which is identifiable in the Patent Office of the U.S. by Application No. 29/552,725 filed on January 25, 2016.

WHEREAS, Shenzhen Yateks Optical Electronic Technology Co., Ltd., a corporation organized and existing under the laws of China ("Assignee"), and having offices at 1101-1104, 11F, Block B, Plant 3, Tian'an Cyber Innovation Park, City Center, Longgang District, Shenzhen, Guangdong, 518000, China is desirous of acquiring the entire right, title and interest in and to the invention, the applications, and any and all Letters Patent or similar foreign or domestic legal protection

- ☒ In the United States
- ☐ In all other countries or jurisdictions;

"NOW THEREFORE, for good and valuable consideration, the receipt and adequacy of which is hereby acknowledged,

- a) we agree to transfer, and
- b) we do hereby transfer,

to Assignee, its successors and assigns, effective as of October 14, 2015 *nunc pro tunc*, our entire right, title and interest in the above named countries and jurisdictions in and to the following including the right to sue for past infringement: the invention, the above-identified applications, all applications from which any of the above-identified applications claim priority, corresponding U.S. and non-U.S. applications, any continuation, division, renewal, or substitute for the applications, all Letters Patent, any reissue, re-examination, or similar legal protection issuing related to the Letters Patent, and all rights and benefits under any applicable treaty or convention, and I/we authorize the Director of the United States Patent and Trademark Office or foreign equivalent to issue the Letters Patent or similar legal protection to the Assignee."

We authorize the U.S. Attorneys handling this matter in the U.S. and the Assignee, its successors and assigns, to insert in this instrument the filing date(s) and application numbers when ascertained. We further authorize the Assignee, its successors and assigns, or anyone it may properly designate, to apply for Letters Patent or similar legal protection, in its own name if desired, in the above named countries and jurisdictions and appoint Assignee the common representative in the above-identified international application and any international application for the invention.

We represent to the Assignee, its successors and assigns, that we shall not execute any writing or do any act whatsoever conflicting with this Assignment. We, our executors or administrators, will at any time upon request, without additional consideration, but at the expense of the Assignee, its successors and assigns, execute and deliver to Assignee or its legal representatives such additional writings and do such additional acts as the Assignee, its successors and assigns, may deem desirable to perfect its enjoyment of this grant, and render all assistance in making application for and obtaining, maintaining, and enforcing the Letters Patent or similar legal protection on the invention in any and all countries and jurisdictions, including without

limitation providing testimony in any related interference, litigation or proceeding. To the extent that we, our executors or administrators are unable or unavailable to execute and deliver to Assignee or its legal representatives such additional writings and do such additional acts as Assignee, its successors and assigns may deem desirable to perfect its enjoyment of this grant, and render all assistance in making application for and obtaining, maintaining, and enforcing the Letters Patent or similar legal protection on the invention in any and all countries and jurisdictions, we, our executors or administrators hereby authorize Assignee, its successors and assigns to act on our behalf.

If any provision(s) of this Assignment are held unenforceable or in conflict with the law of any jurisdiction, the validity of the remaining provisions will not be affected by such holding and the part held unenforceable in or in conflict with the law of one jurisdiction will remain in effect for other jurisdictions until held unenforceable or in conflict with the law of that jurisdiction.

Jiangfan YAN

(Inventor / Assignor)

Date

Quan ZHONG

(Inventor / Assignor)

Date

Wei PENG

(Inventor / Assignor)

Date

Tianyue MA

(Inventor / Assignor)

Date

2016.1.23

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